

COMPONENT AND METHOD FOR
MANUFACTURING PRINTED CIRCUIT BOARDS

ABSTRACT OF THE DISCLOSURE

A laminated component includes a conductive film layer and a non-functional film layer joined to a first surface of the conductive film layer. One of the two film layers has larger lateral dimensions than the other film layer such that a portion of the larger film layer extends beyond the other film layer. In one embodiment, the two film layers are joined together by a band of adhesive defining a sealed central area inwardly thereof, and the portion of larger film layer extends beyond the other film layer on all sides thereof.